



SBRFP2M60SAFQ

2A FIELD PLATED SBR FIELD PLATED SUPER BARRIER RECTIFIER SMAF

Product Summary (@ TJ = +25°C)

VRRM (V)	lo (A)	VF (MAX) (V)	IR (MAX) (μ A)
60	2	0.58	12

Description

This field plated Super Barrier Rectifier (SBR®FP) diode is ideally suited for application requiring ultra-low blocking mode. Leading to lower operating temperatures and increased system reliability. Packaged in the robust industry-standard SMAF package.

Applications

- DC-DC converters
- AC-DC rectifiers
- · Reverse polarity protections
- SMPS
- · Freewheeling applications
- Low-power consumption applications

Features

- Patented SBR Technology Provides an Avalanche Capability Five Times Larger than Schottky Diodes Ensuring More Rugged and Reliable End Applications
- Lower Reverse Leakage Ensuring Greater Stability at Higher Temperatures
- Low-Forward Voltage (V_F) Minimizes Conduction Losses and Improving Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The SBRFP2M60SAFQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SMAF
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- · Polarity: Cathode Band
- Weight: 0.035 grams (Approximate)

SMAF



Top View

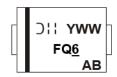
Ordering Information (Note 4)

Packing			king	
Orderable Part Number	Package	Qty. Carrier		
SBRFP2M60SAFQ-13	SMAF	10000	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



FQ6 = Product Type Marking Code

OH = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 5 for 2025)

WW = Week Code (01 to 53)

AB = Foundry and Assembly Code

SBR is a registered trademark of Diodes Incorporated.



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	VRWM	60	V
DC Blocking Voltage	V _{RM}		
Average Rectified Output Current	lo	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed on Rated Load	IFSM	24.5	А
Non-Repetitive Avalanche Energy (T _J = +25°C, I _{AS} = 2.2A, L = 15mH)	E _{AS}	53	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance Junction to Case (Note 5)	Rejc	37	°C/W	
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	99	C/VV	
Operating and Storage Temperature Range (Note 6)	T _J , T _{STG}	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

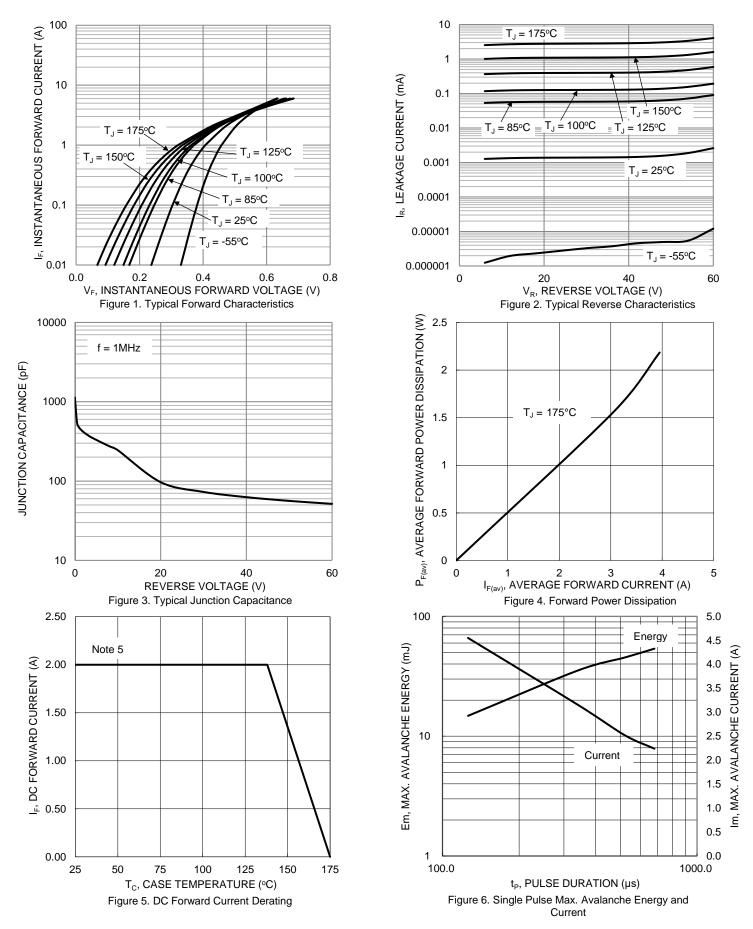
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop		_	0.41	_	V	I _F = 1A, T _J = +25°C
	\/-	_	0.35	_	V	I _F = 1A, T _J = +125°C
	VF	_	0.47	0.58	V	IF = 2A, T _J = +25°C
	_	_	0.44	0.55	V	I _F = 2A, T _J = +125°C
Lastrana Commant (Nata 7)	1-	_	2.6	12	μA	V _R = 60V, T _J = +25°C
Leakage Current (Note 7)	IR	_	0.6	3	mA	$V_R = 60V, T_J = +125$ °C
Junction Capacitance	CJ	_	51	_	pF	$V_R = 60V, T_J = +25^{\circ}C$
Reverse-Recovery Time	t _{RR}	_	15	_	ns	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A, T _A = +25°C

Notes:

- 5. Device mounted on FR-4 substrate, 1" * 1", 2oz, single-sided, PC boards with 0.06" * 0.09" copper pad.
- 6. The heat generated must be less than the thermal conductivity from junction to case: $dP_D/dT_J < 1/R_{\theta JC}$ or junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$.
- 7. Short duration pulse test used to minimize self-heating effect.





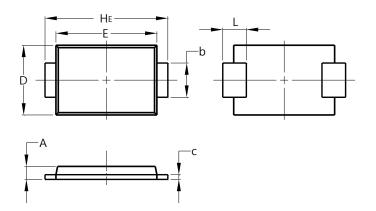




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF

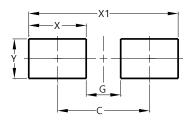


SMAF				
Dim	Min	Max		
Α	0.90	1.10		
b	1.25	1.65		
C	0.10	0.40		
D	2.25	2.95		
Е	3.95	4.60		
H _E	4.80	5.60		
٦	0.50	1.50		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF



Dimensions	Value (in mm)		
С	4.00		
G	1.50		
Х	2.50		
X1	6.50		
Υ	1.70		



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